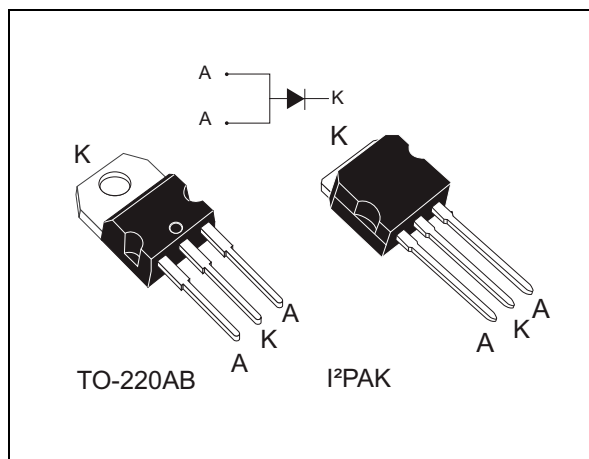




Description

This single rectifier is based on a proprietary technology, enabling to achieve the best in class V_F/I_R trade-off for a given silicon surface.

Packaged in TO-220AB and I²PAK, this device is intended to be used in rectification and freewheeling operations in switch-mode power supplies.

Table 1. Device summary

Symbol	Value
$I_{F(AV)}$	20 A
V_{RRM}	60 V
T_j (max)	+175 °C
V_F (typ)	0.30 V

Features

- ST proprietary process
- Stable leakage current over reverse voltage
- Low forward voltage drop
- High frequency operation

1 Characteristics

Table 2. Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		60	V
$I_{F(RMS)}$	Forward rms current		60	A
$I_{F(AV)}$	Average forward current, $\delta = 0.5$	$T_c = 150\text{ °C}$	20	A
I_{FSM}	Surge non repetitive forward current	$t_p = 10\text{ ms}$ sinusoidal	275	A
T_{stg}	Storage temperature range		-65 to + 175	°C
$T_j^{(1)}$	Maximum operating junction temperature		175	°C

1. $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 3. Thermal resistance

Symbol	Parameter	Value (max)	Unit
$R_{th(j-c)}$	Junction to case	1.6	°C/W

Table 4. Static electrical characteristics (per diode)

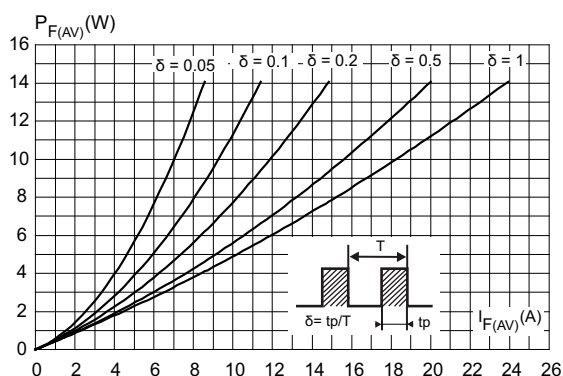
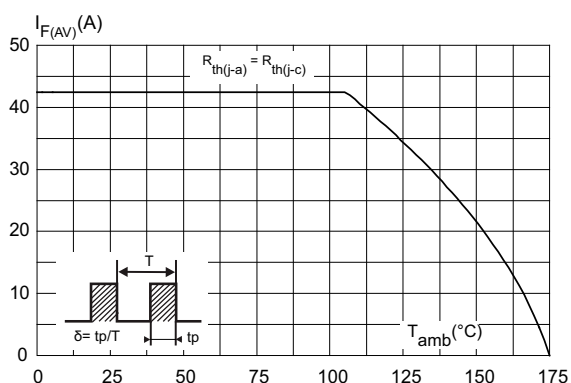
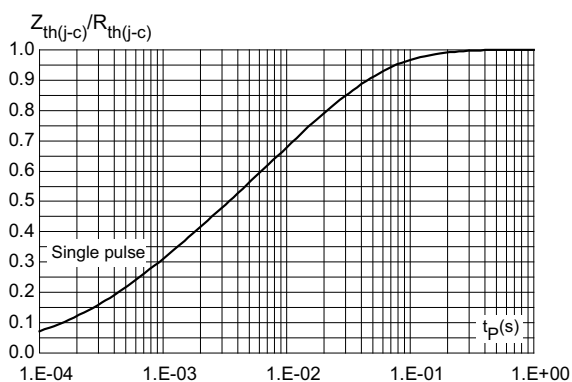
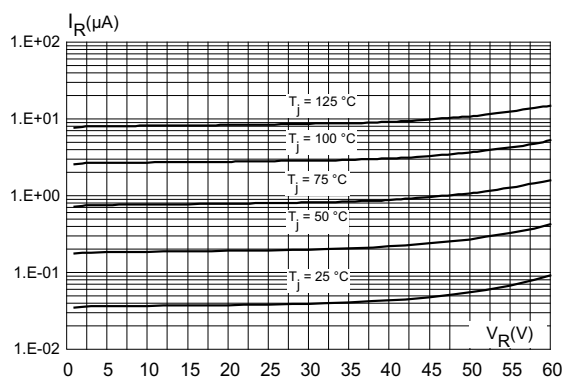
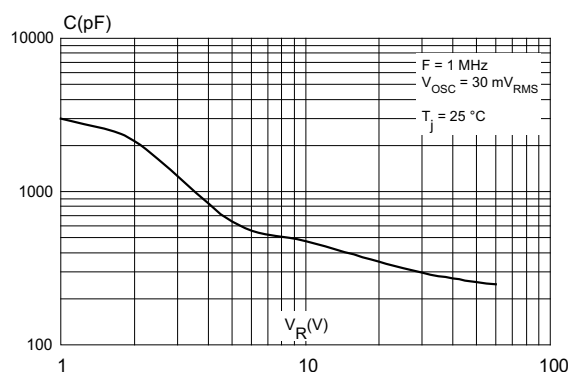
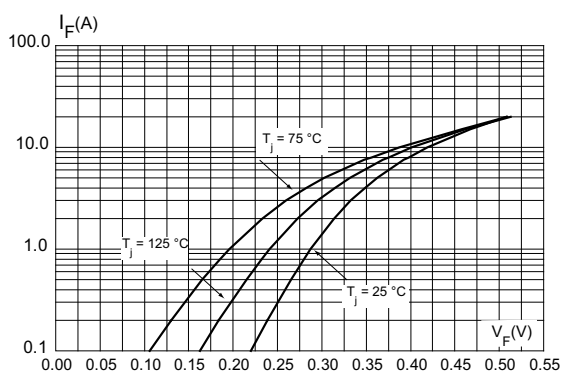
Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = 45\text{ V}$			125	μA
		$T_j = 125\text{ °C}$			10	20	mA
		$T_j = 25\text{ °C}$	$V_R = V_{RRM}$			230	μA
		$T_j = 125\text{ °C}$			15	30	mA
$V_F^{(2)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 5\text{ A}$		0.36		V
		$T_j = 125\text{ °C}$			0.30	0.35	
		$T_j = 25\text{ °C}$	$I_F = 10\text{ A}$		0.42	0.47	
		$T_j = 125\text{ °C}$			0.39	0.44	
		$T_j = 25\text{ °C}$	$I_F = 20\text{ A}$		0.51	0.56	
		$T_j = 125\text{ °C}$			0.51	0.56	

1. Pulse test: $t_p = 5\text{ ms}$, $\delta < 2\%$

2. Pulse test: $t_p = 380\text{ μs}$, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.32 \times I_{F(AV)} + 0.012 I_{F(RMS)}^2$$

Figure 1. Average forward power dissipation versus average forward current**Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$)****Figure 3. Relative variation of thermal impedance junction to case versus pulse duration****Figure 4. Reverse leakage current versus reverse voltage applied (typical values)****Figure 5. Junction capacitance versus reverse voltage applied (typical values)****Figure 6. Forward voltage drop versus forward current (typical values)**

2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 N·m
- Maximum torque value: 0.7 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 TO-220AB package information

Figure 7. TO-220AB package outline

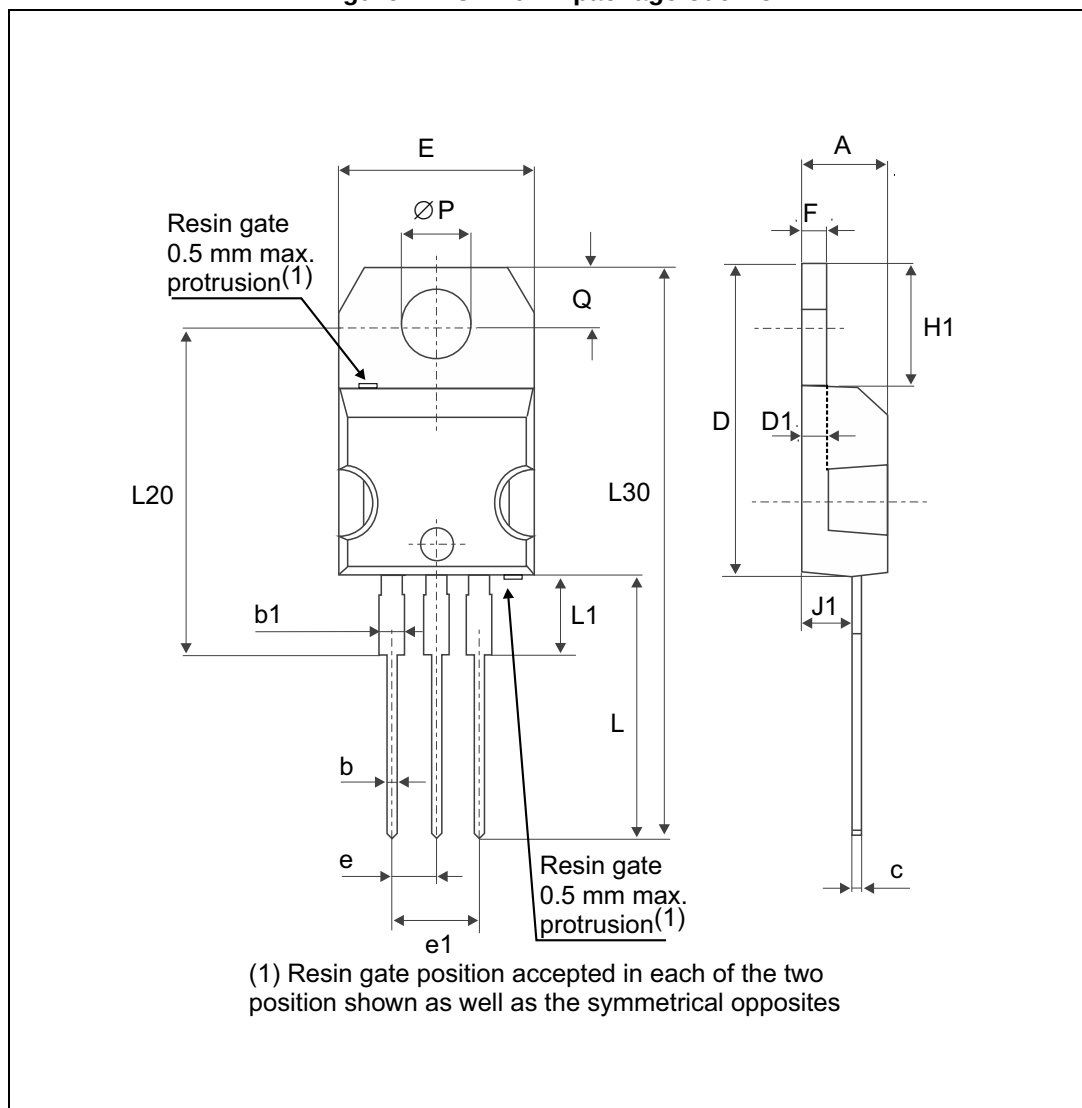
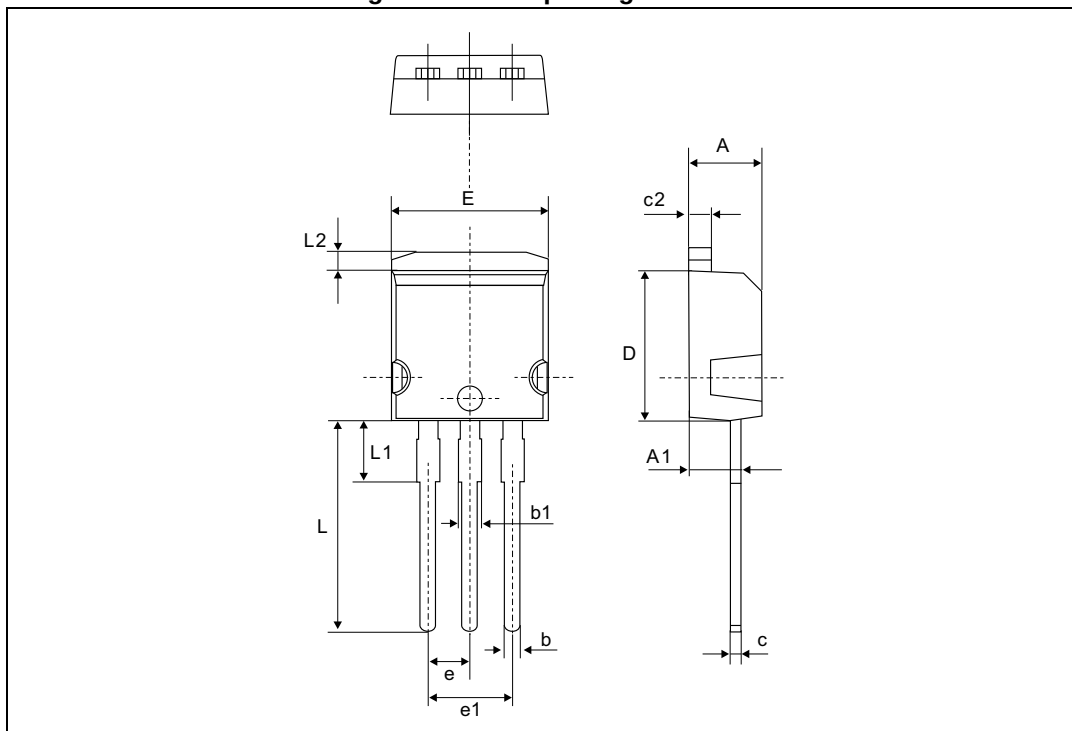


Table 5. TO-220AB package mechanical data

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.17	0.18
b	0.61	0.88	0.024	0.035
b1	1.14	1.70	0.045	0.067
c	0.48	0.70	0.019	0.027
D	15.25	15.75	0.60	0.62
D1	1.27 typ.		0.05 typ.	
E	10	10.40	0.39	0.41
e	2.40	2.70	0.094	0.106
e1	4.95	5.15	0.19	0.20
F	1.23	1.32	0.048	0.052
H1	6.20	6.60	0.24	0.26
J1	2.40	2.72	0.094	0.107
L	13	14	0.51	0.55
L1	3.50	3.93	0.137	0.154
L20	16.40 typ.		0.64 typ.	
L30	28.90 typ.		1.13 typ.	
ØP	3.75	3.85	0.147	0.151
Q	2.65	2.95	0.104	0.116

2.2 I²PAK package information

Figure 8. I²PAK package outlineTable 6. I²PAK package mechanical data

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.40	4.60	0.173	0.181
A1	2.40	2.72	0.094	0.107
b	0.61	0.88	0.024	0.035
b1	1.14	1.70	0.044	0.067
c	0.49	0.70	0.019	0.028
c2	1.23	1.32	0.048	0.052
D	8.95	9.35	0.352	0.368
e	2.40	2.70	0.094	0.106
e1	4.95	5.15	0.195	0.203
E	10	10.40	0.394	0.409
L	13	14	0.512	0.551
L1	3.50	3.93	0.138	0.155
L2	1.27	1.40	0.050	0.055

3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
FERD20M60ST	FERD20M60ST	TO-220AB	1.9 g	50	Tube
FERD20M60SR	FERD20M60SR	I ² PAK	1.4 g	50	Tube

4 Revision history

Table 8. Document revision history

Date	Revision	Changes
20-Nov-2014	1	Initial release.
17-Jun-2015	2	Added I ² PAK package information.

IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2015 STMicroelectronics – All rights reserved